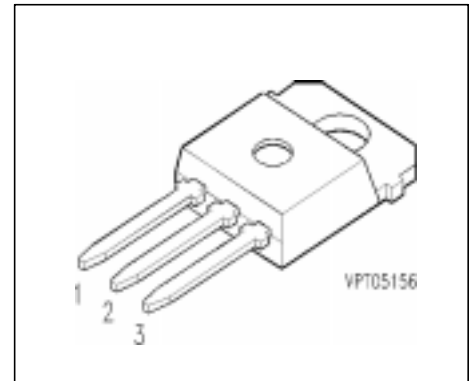


#### IGBT

- High switching speed
- Very low switching losses
- Low tail current
- Latch-up free
- Avalanche rated



Pin 1	Pin 2	Pin 3
G	C	E

Type	$V_{CE}$	$I_C$	Package	Ordering Code
BUP 314S	1200V	25A	TO-218 AB	C67040-A4207-A2

#### Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	$V_{CE}$	1200	V
Collector-gate voltage	$V_{CGR}$	1200	
$R_{GE} = 20 \text{ k}\Omega$			
Gate-emitter voltage	$V_{GE}$	$\pm 20$	
DC collector current	$I_C$		A
$T_C = 25 \text{ }^\circ\text{C}$		25	
$T_C = 90 \text{ }^\circ\text{C}$		17	
Pulsed collector current, $t_p = 1 \text{ ms}$	$I_{Cpuls}$		
$T_C = 25 \text{ }^\circ\text{C}$		50	
$T_C = 90 \text{ }^\circ\text{C}$		34	
Avalanche energy, single pulse	$E_{AS}$		mJ
$I_C = 25 \text{ A}$ , $V_{CC} = 50 \text{ V}$ , $R_{GE} = 25 \text{ }\Omega$ $L = 200 \text{ }\mu\text{H}$ , $T_j = 25 \text{ }^\circ\text{C}$		65	
Power dissipation	$P_{tot}$		W
$T_C = 25 \text{ }^\circ\text{C}$		300	
Chip or operating temperature	$T_j$	-55 ... + 150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 ... + 150	

### Maximum Ratings

Parameter	Symbol	Values	Unit
DIN humidity category, DIN 40 040	-	E	-
IEC climatic category, DIN IEC 68-1	-	55 / 150 / 56	

### Thermal Resistance

Thermal resistance, chip case	$R_{thJC}$	$\leq 0.42$	K/W
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### Electrical Characteristics, at $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Static Characteristics

Collector-emitter breakdown voltage $V_{GE} = 0\text{ V}$ , $I_C = 0.3\text{ mA}$ , $T_j = 25\text{ °C}$	$V_{(BR)CES}$	1200	-	-	V
Gate threshold voltage $V_{GE} = V_{CE}$ , $I_C = 0.35\text{ mA}$ , $T_j = 25\text{ °C}$	$V_{GE(th)}$	4.5	5.5	6.5	
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}$ , $I_C = 15\text{ A}$ , $T_j = 25\text{ °C}$	$V_{CE(sat)}$	-	5.5	7.6	
$V_{GE} = 15\text{ V}$ , $I_C = 15\text{ A}$ , $T_j = 125\text{ °C}$		-	4.6	-	
$V_{GE} = 15\text{ V}$ , $I_C = 30\text{ A}$ , $T_j = 25\text{ °C}$		-	8	-	
$V_{GE} = 15\text{ V}$ , $I_C = 30\text{ A}$ , $T_j = 125\text{ °C}$		-	6.6	-	
Zero gate voltage collector current $V_{CE} = 1200\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_j = 25\text{ °C}$	$I_{CES}$	-	-	0.8	mA
Gate-emitter leakage current $V_{GE} = 25\text{ V}$ , $V_{CE} = 0\text{ V}$	$I_{GES}$	-	-	100	nA

### AC Characteristics

Transconductance $V_{CE} = 20 \text{ V}, I_C = 15 \text{ A}$	$g_{fs}$	8.5	12	-	S
Input capacitance $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	$C_{iss}$	-	1950	2600	pF
Output capacitance $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	$C_{oss}$	-	180	270	
Reverse transfer capacitance $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	$C_{rss}$	-	120	180	

### Electrical Characteristics, at $T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

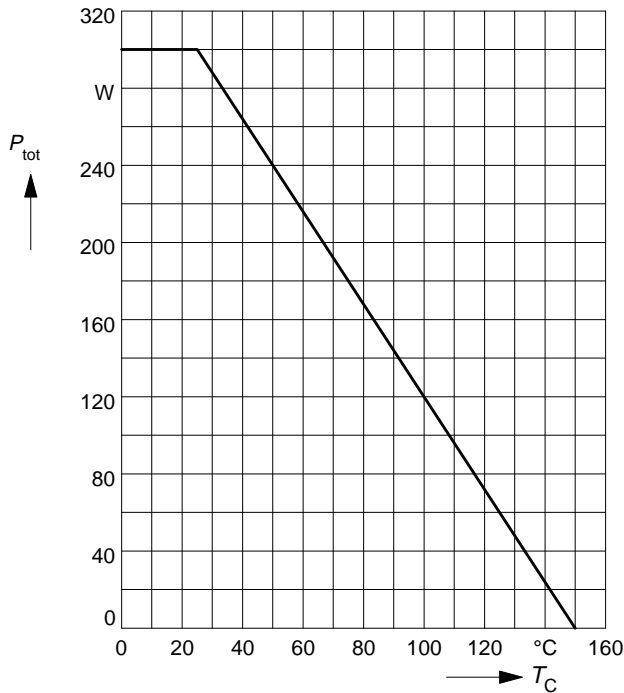
### Switching Characteristics, Inductive Load at $T_j = 125 \text{ }^\circ\text{C}$

Turn-on delay time $V_{CC} = 600 \text{ V}, V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}$ $R_{Gon} = 47 \text{ } \Omega$	$t_{d(on)}$	-	65	100	ns
Rise time $V_{CC} = 600 \text{ V}, V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}$ $R_{Gon} = 47 \text{ } \Omega$	$t_r$	-	60	90	
Turn-off delay time $V_{CC} = 600 \text{ V}, V_{GE} = -15 \text{ V}, I_C = 15 \text{ A}$ $R_{Goff} = 47 \text{ } \Omega$	$t_{d(off)}$	-	420	560	
Fall time $V_{CC} = 600 \text{ V}, V_{GE} = -15 \text{ V}, I_C = 15 \text{ A}$ $R_{Goff} = 47 \text{ } \Omega$	$t_f$	-	70	95	

### Power dissipation

$$P_{\text{tot}} = f(T_C)$$

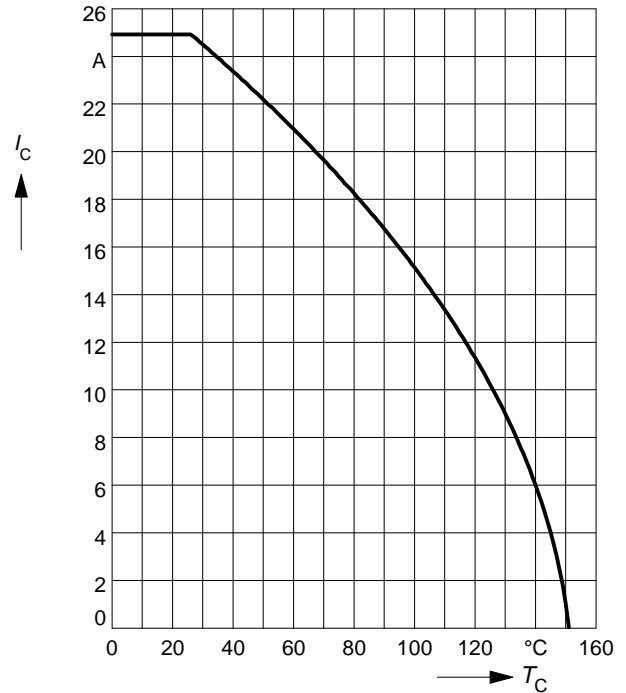
parameter:  $T_j \leq 150^\circ\text{C}$



### Collector current

$$I_C = f(T_C)$$

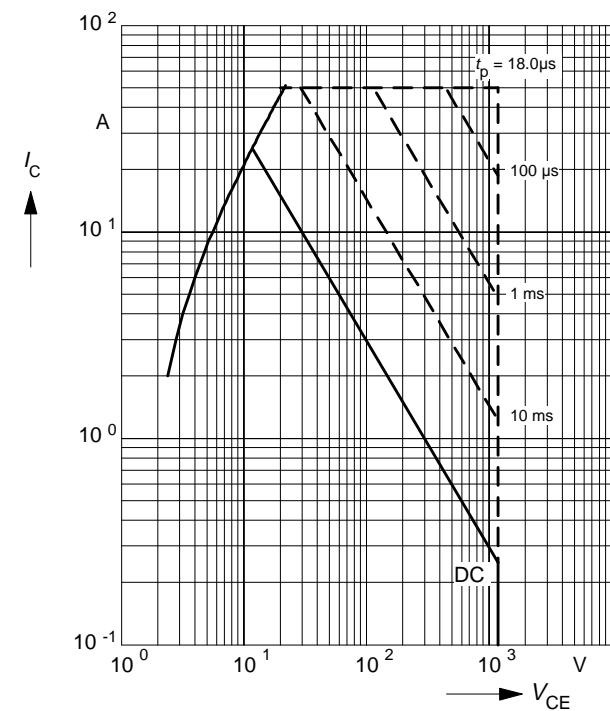
parameter:  $V_{\text{GE}} \geq 15\text{ V}$ ,  $T_j \leq 150^\circ\text{C}$



### Safe operating area

$$I_C = f(V_{\text{CE}})$$

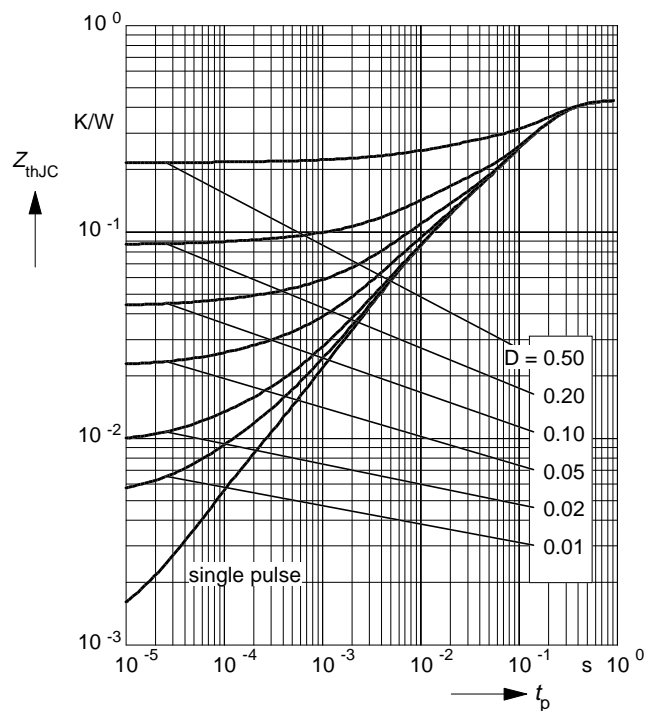
parameter:  $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$



### Transient thermal impedance IGBT

$$Z_{\text{thJC}} = f(t_p)$$

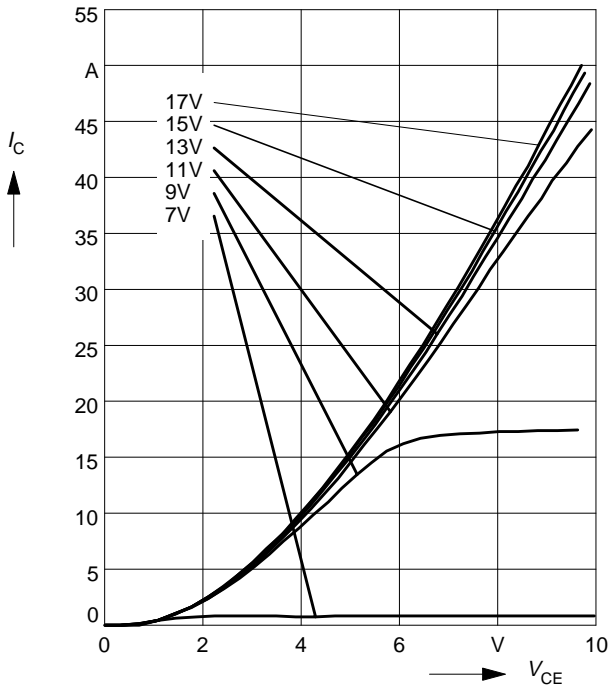
parameter:  $D = t_p / T$



**Typ. output characteristics**

$I_C = f(V_{CE})$

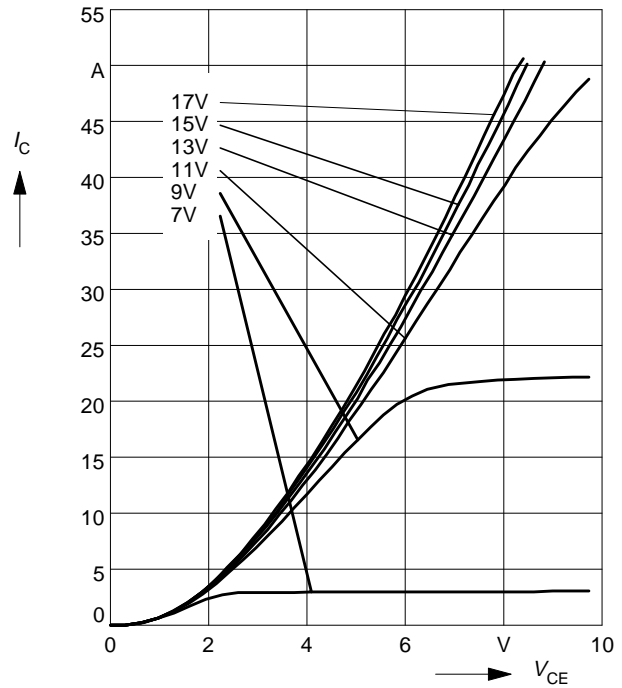
parameter:  $t_p = 80 \mu s, T_j = 25 \text{ }^\circ\text{C}$



**Typ. output characteristics**

$I_C = f(V_{CE})$

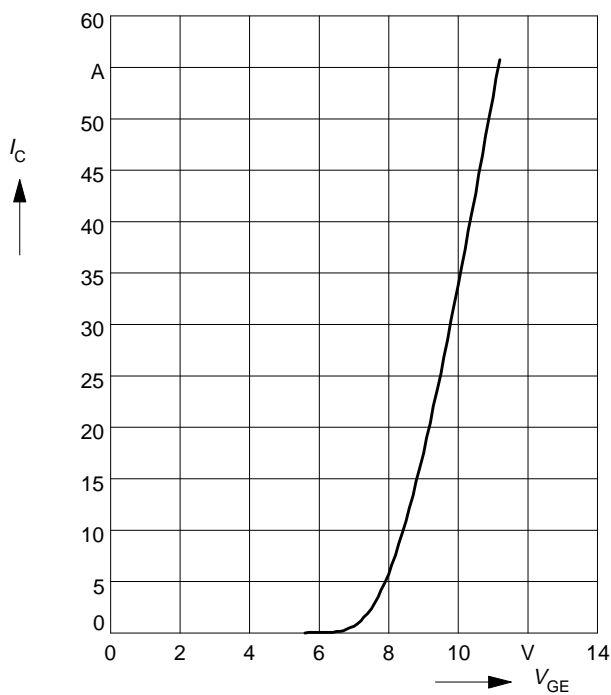
parameter:  $t_p = 80 \mu s, T_j = 125 \text{ }^\circ\text{C}$



**Typ. transfer characteristics**

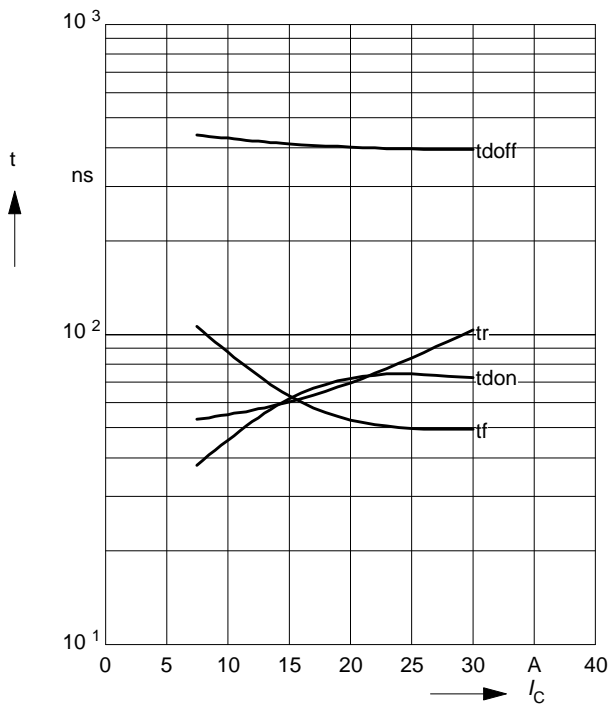
$I_C = f(V_{GE})$

parameter:  $t_p = 80 \mu s, V_{CE} = 20 \text{ V}$



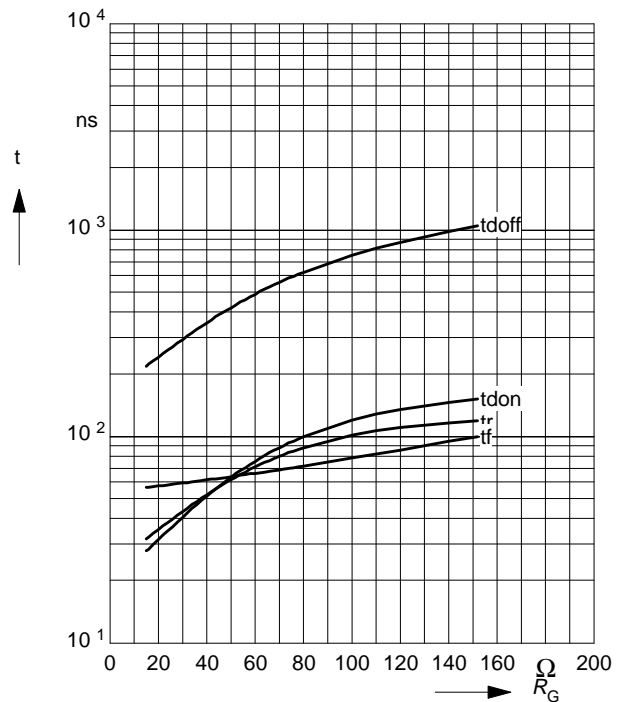
### Typ. switching time

$t = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 47\Omega$



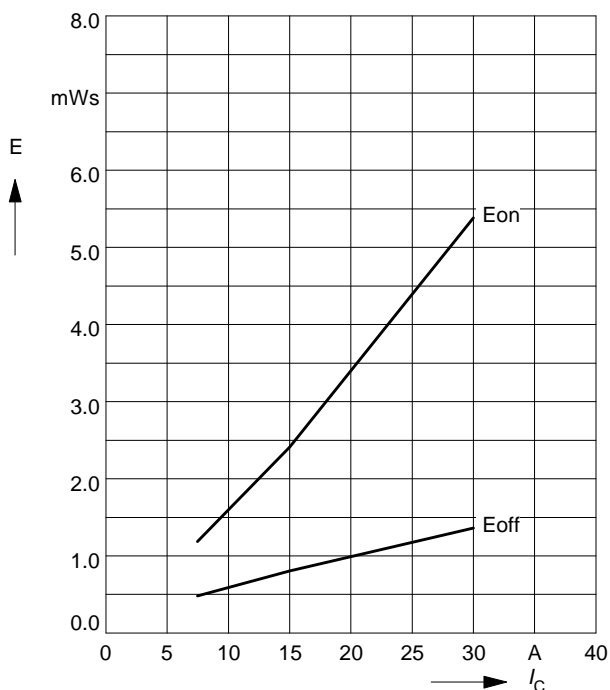
### Typ. switching time

$t = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 15\text{ A}$



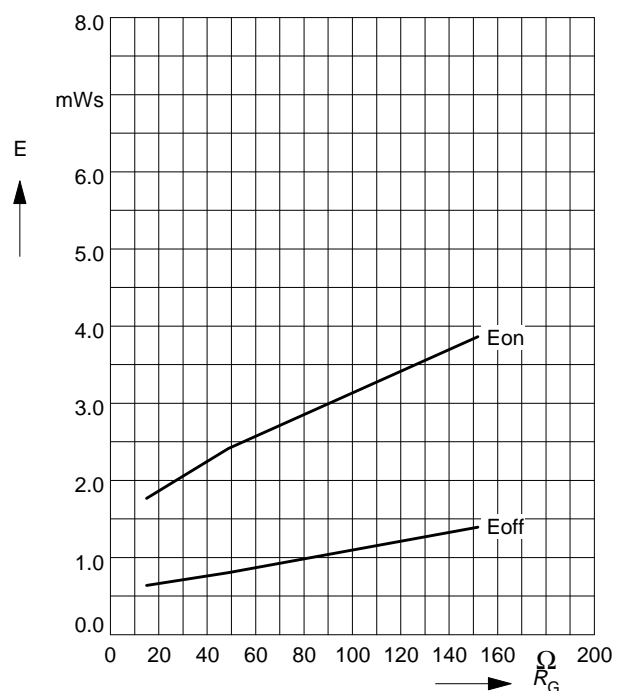
### Typ. switching losses

$E = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 48.9\Omega$



### Typ. switching losses

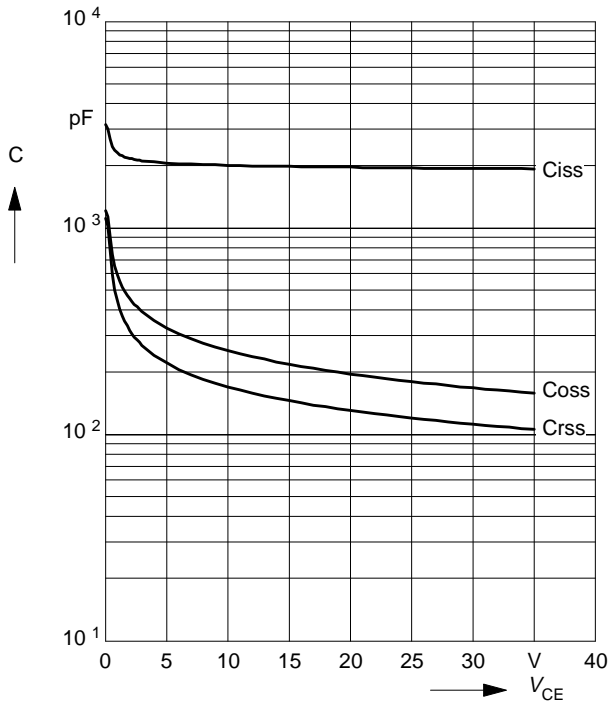
$E = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 15\text{ A}$



### Typ. capacitances

$$C = f(V_{CE})$$

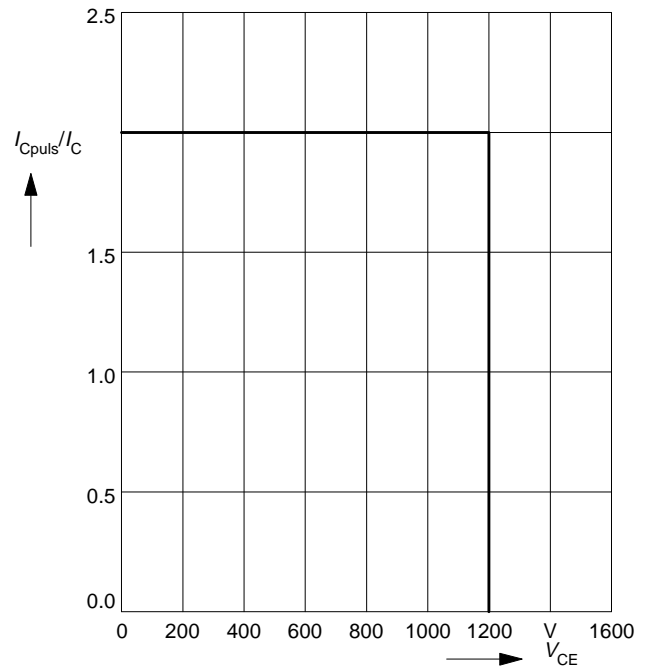
parameter:  $V_{GE} = 0 \text{ V}$ ,  $f = 1 \text{ MHz}$



### Reverse biased safe operating area

$$I_{Cpuls} = f(V_{CE}), T_j = 150^\circ\text{C}$$

parameter:  $V_{GE} = 15 \text{ V}$



### Short circuit safe operating area

$$I_{Csc} = f(V_{CE}), T_j = 150^\circ\text{C}$$

parameter:  $V_{GE} = \pm 15 \text{ V}$ ,  $t_{sc} \leq 10 \mu\text{s}$ ,  $L < 25 \text{ nH}$

